

# BAV99 series

## High-speed switching diodes

Rev. 8 — 18 November 2010

Product data sheet

## 1. Product profile

### 1.1 General description

High-speed switching diodes, encapsulated in small Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

| Type number | Package |       |          | Configuration       | Package configuration |
|-------------|---------|-------|----------|---------------------|-----------------------|
|             | NXP     | JEITA | JEDEC    |                     |                       |
| BAV99       | SOT23   | -     | TO-236AB | dual series         | small                 |
| BAV99S      | SOT363  | SC-88 | -        | quadruple; 2 series | very small            |
| BAV99W      | SOT323  | SC-70 | -        | dual series         | very small            |

### 1.2 Features and benefits

- High switching speed:  $t_{rr} \leq 4$  ns
- Low leakage current
- Small SMD plastic packages
- Low capacitance:  $C_d \leq 1.5$  pF
- Reverse voltage:  $V_R \leq 100$  V
- AEC-Q101 qualified

### 1.3 Applications

- High-speed switching
- General-purpose switching
- Reverse polarity protection

### 1.4 Quick reference data

Table 2. Quick reference data

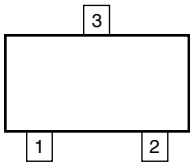
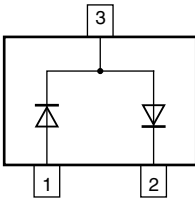
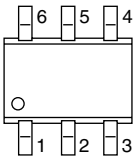
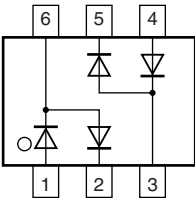
| Symbol    | Parameter             | Conditions   | Min | Typ | Max | Unit    |
|-----------|-----------------------|--------------|-----|-----|-----|---------|
| Per diode |                       |              |     |     |     |         |
| $I_R$     | reverse current       | $V_R = 80$ V | -   | -   | 0.5 | $\mu$ A |
| $V_R$     | reverse voltage       |              | -   | -   | 100 | V       |
| $t_{rr}$  | reverse recovery time |              | [1] | -   | 4   | ns      |

[1] When switched from  $I_F = 10$  mA to  $I_R = 10$  mA;  $R_L = 100$   $\Omega$ ; measured at  $I_R = 1$  mA.



## 2. Pinning information

Table 3. Pinning

| Pin           | Description                           | Simplified outline                                                                               | Graphic symbol                                                                                    |
|---------------|---------------------------------------|--------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|
| BAV99; BAV99W |                                       |                                                                                                  |                                                                                                   |
| 1             | anode (diode 1)                       | <br>006aaa144 | <br>006aaa763  |
| 2             | cathode (diode 2)                     |                                                                                                  |                                                                                                   |
| 3             | cathode (diode 1),<br>anode (diode 2) |                                                                                                  |                                                                                                   |
| BAV99S        |                                       |                                                                                                  |                                                                                                   |
| 1             | anode (diode 1)                       |              | <br>006aab101 |
| 2             | cathode (diode 2)                     |                                                                                                  |                                                                                                   |
| 3             | cathode (diode 3),<br>anode (diode 4) |                                                                                                  |                                                                                                   |
| 4             | anode (diode 3)                       |                                                                                                  |                                                                                                   |
| 5             | cathode (diode 4)                     |                                                                                                  |                                                                                                   |
| 6             | cathode (diode 1),<br>anode (diode 2) |                                                                                                  |                                                                                                   |

## 3. Ordering information

Table 4. Ordering information

| Type number | Package |                                          |         |
|-------------|---------|------------------------------------------|---------|
|             | Name    | Description                              | Version |
| BAV99       | -       | plastic surface-mounted package; 3 leads | SOT23   |
| BAV99S      | SC-88   | plastic surface-mounted package; 6 leads | SOT363  |
| BAV99W      | SC-70   | plastic surface-mounted package; 3 leads | SOT323  |

## 4. Marking

Table 5. Marking codes

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| BAV99       | A7*                         |
| BAV99S      | K1*                         |
| BAV99W      | A7*                         |

[1] \* = placeholder for manufacturing site code

## 5. Limiting values

**Table 6. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol            | Parameter                           | Conditions                               | Min    | Max  | Unit             |
|-------------------|-------------------------------------|------------------------------------------|--------|------|------------------|
| <b>Per diode</b>  |                                     |                                          |        |      |                  |
| $V_{RRM}$         | repetitive peak reverse voltage     |                                          | -      | 100  | V                |
| $V_R$             | reverse voltage                     |                                          | -      | 100  | V                |
| $I_F$             | forward current                     |                                          |        |      |                  |
|                   | BAV99                               |                                          | [1] -  | 215  | mA               |
|                   |                                     |                                          | [2] -  | 125  | mA               |
|                   | BAV99S                              |                                          | [1] -  | 200  | mA               |
|                   | BAV99W                              |                                          | [1] -  | 150  | mA               |
|                   |                                     |                                          | [2] -  | 130  | mA               |
| $I_{FRM}$         | repetitive peak forward current     |                                          | -      | 500  | mA               |
| $I_{FSM}$         | non-repetitive peak forward current | square wave                              | [3]    |      |                  |
|                   |                                     | $t_p = 1 \mu s$                          | -      | 4    | A                |
|                   |                                     | $t_p = 1 ms$                             | -      | 1    | A                |
|                   |                                     | $t_p = 1 s$                              | -      | 0.5  | A                |
| $P_{tot}$         | total power dissipation             |                                          | [1][4] |      |                  |
|                   | BAV99                               | $T_{amb} \leq 25 \text{ }^\circ\text{C}$ | -      | 250  | mW               |
|                   | BAV99S                              | $T_{sp} \leq 85 \text{ }^\circ\text{C}$  | [5] -  | 250  | mW               |
|                   | BAV99W                              | $T_{amb} \leq 25 \text{ }^\circ\text{C}$ | -      | 200  | mW               |
| <b>Per device</b> |                                     |                                          |        |      |                  |
| $T_j$             | junction temperature                |                                          | -      | 150  | $^\circ\text{C}$ |
| $T_{amb}$         | ambient temperature                 |                                          | -65    | +150 | $^\circ\text{C}$ |
| $T_{stg}$         | storage temperature                 |                                          | -65    | +150 | $^\circ\text{C}$ |

[1] Single diode loaded.

[2] Double diode loaded.

[3]  $T_j = 25 \text{ }^\circ\text{C}$  prior to surge.

[4] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[5] Soldering points at pins 2, 3, 5 and 6.

## 6. Thermal characteristics

**Table 7. Thermal characteristics**

| Symbol         | Parameter                                        | Conditions  | Min    | Typ | Max | Unit |
|----------------|--------------------------------------------------|-------------|--------|-----|-----|------|
| $R_{th(j-a)}$  | thermal resistance from junction to ambient      | in free air | [1][2] |     |     |      |
|                | BAV99                                            |             | -      | -   | 500 | K/W  |
|                | BAV99W                                           |             | -      | -   | 625 | K/W  |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point |             |        |     |     |      |
|                | BAV99                                            |             | -      | -   | 360 | K/W  |
|                | BAV99S                                           | [3]         | -      | -   | 260 | K/W  |
|                | BAV99W                                           |             | -      | -   | 300 | K/W  |

[1] Single diode loaded.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Soldering points at pins 2, 3, 5 and 6.

## 7. Characteristics

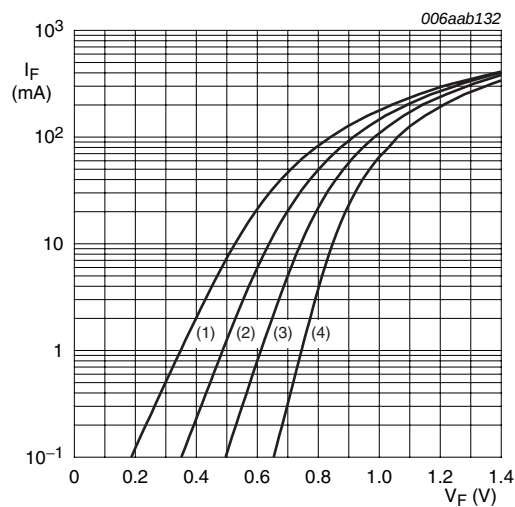
**Table 8. Characteristics**

$T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

| Symbol           | Parameter                | Conditions                                             | Min | Typ | Max  | Unit          |
|------------------|--------------------------|--------------------------------------------------------|-----|-----|------|---------------|
| <b>Per diode</b> |                          |                                                        |     |     |      |               |
| $V_F$            | forward voltage          | $I_F = 1\text{ mA}$                                    | -   | -   | 715  | mV            |
|                  |                          | $I_F = 10\text{ mA}$                                   | -   | -   | 855  | mV            |
|                  |                          | $I_F = 50\text{ mA}$                                   | -   | -   | 1    | V             |
|                  |                          | $I_F = 150\text{ mA}$                                  | -   | -   | 1.25 | V             |
| $I_R$            | reverse current          | $V_R = 25\text{ V}$                                    | -   | -   | 30   | nA            |
|                  |                          | $V_R = 80\text{ V}$                                    | -   | -   | 0.5  | $\mu\text{A}$ |
|                  |                          | $V_R = 25\text{ V}; T_j = 150\text{ }^{\circ}\text{C}$ | -   | -   | 30   | $\mu\text{A}$ |
|                  |                          | $V_R = 80\text{ V}; T_j = 150\text{ }^{\circ}\text{C}$ | -   | -   | 50   | $\mu\text{A}$ |
| $C_d$            | diode capacitance        | $f = 1\text{ MHz}; V_R = 0\text{ V}$                   | -   | -   | 1.5  | pF            |
| $t_{rr}$         | reverse recovery time    | [1]                                                    | -   | -   | 4    | ns            |
| $V_{FR}$         | forward recovery voltage | [2]                                                    | -   | -   | 1.75 | V             |

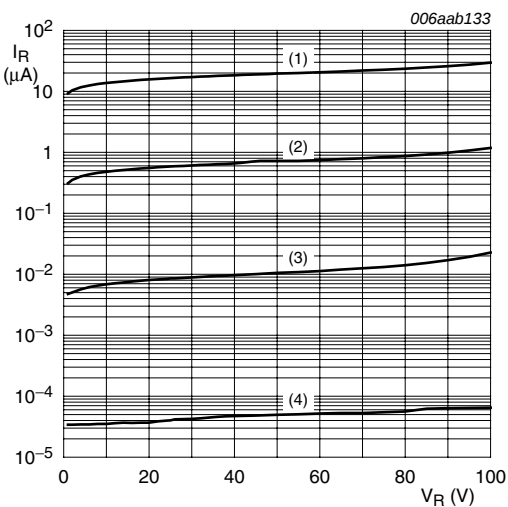
[1] When switched from  $I_F = 10\text{ mA}$  to  $I_R = 10\text{ mA}$ ;  $R_L = 100\text{ }\Omega$ ; measured at  $I_R = 1\text{ mA}$ .

[2] When switched from  $I_F = 10\text{ mA}$ ;  $t_r = 20\text{ ns}$ .



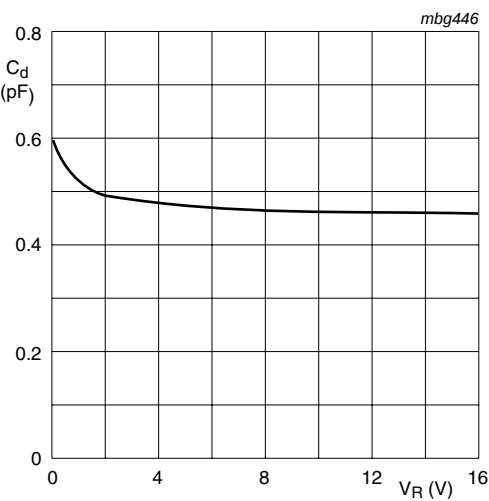
- (1)  $T_{amb} = 150\text{ }^{\circ}\text{C}$
- (2)  $T_{amb} = 85\text{ }^{\circ}\text{C}$
- (3)  $T_{amb} = 25\text{ }^{\circ}\text{C}$
- (4)  $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig 1. Forward current as a function of forward voltage; typical values



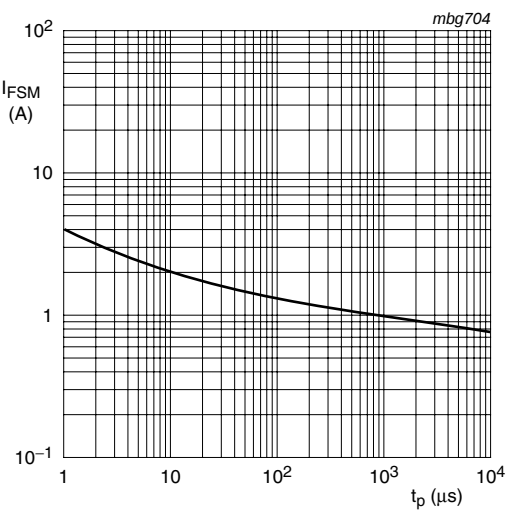
- (1)  $T_{amb} = 150\text{ }^{\circ}\text{C}$
- (2)  $T_{amb} = 85\text{ }^{\circ}\text{C}$
- (3)  $T_{amb} = 25\text{ }^{\circ}\text{C}$
- (4)  $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig 2. Reverse current as a function of reverse voltage; typical values



$f = 1\text{ MHz}; T_{amb} = 25\text{ }^{\circ}\text{C}$

Fig 3. Diode capacitance as a function of reverse voltage; typical values

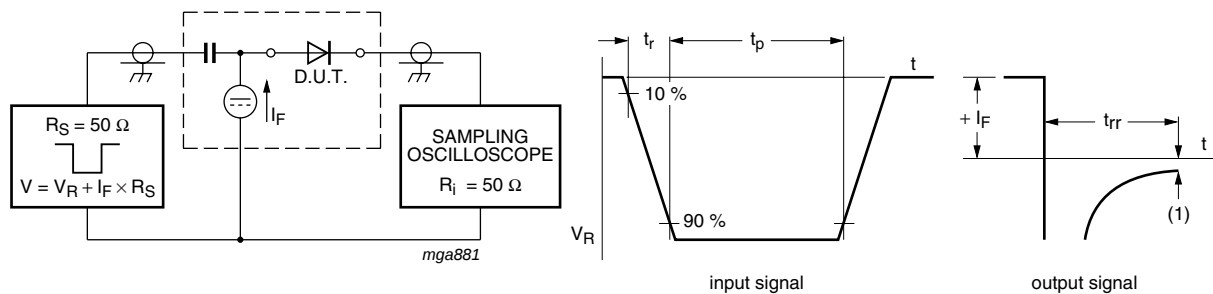


Based on square wave currents.

$T_j = 25\text{ }^{\circ}\text{C}$ ; prior to surge

Fig 4. Non-repetitive peak forward current as a function of pulse duration; maximum values

## 8. Test information

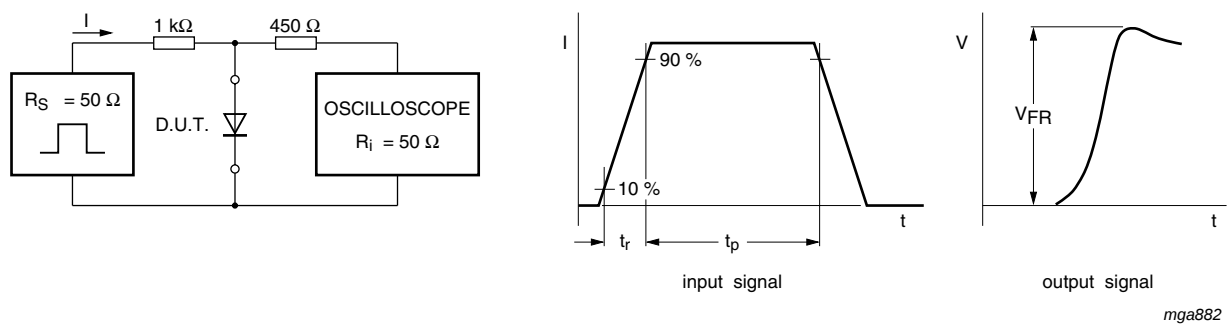


(1)  $I_R = 1 \text{ mA}$

Input signal: reverse pulse rise time  $t_r = 0.6 \text{ ns}$ ; reverse voltage pulse duration  $t_p = 100 \text{ ns}$ ; duty cycle  $\delta = 0.05$

Oscilloscope: rise time  $t_r = 0.35 \text{ ns}$

**Fig 5. Reverse recovery time test circuit and waveforms**



Input signal: forward pulse rise time  $t_r = 20 \text{ ns}$ ; forward current pulse duration  $t_p \geq 100 \text{ ns}$ ; duty cycle  $\delta \leq 0.005$

**Fig 6. Forward recovery voltage test circuit and waveforms**

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 9. Package outline

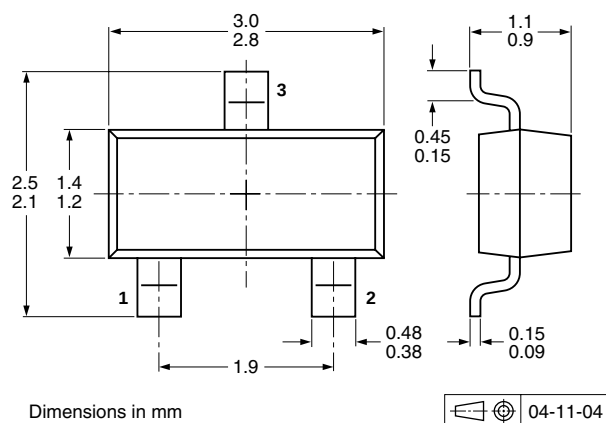


Fig 7. Package outline BAV99 (SOT23/TO-236AB)

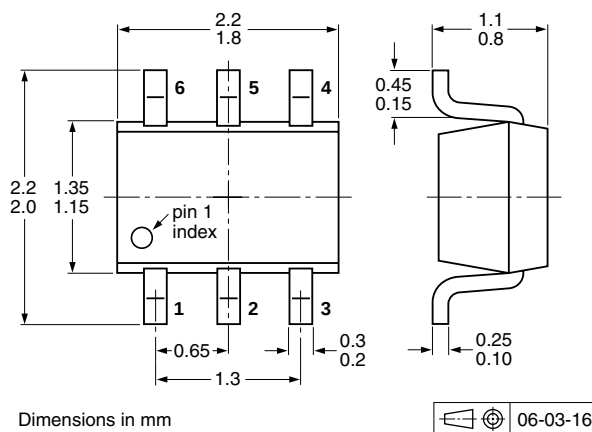


Fig 8. Package outline BAV99S (SOT363/SC-88)

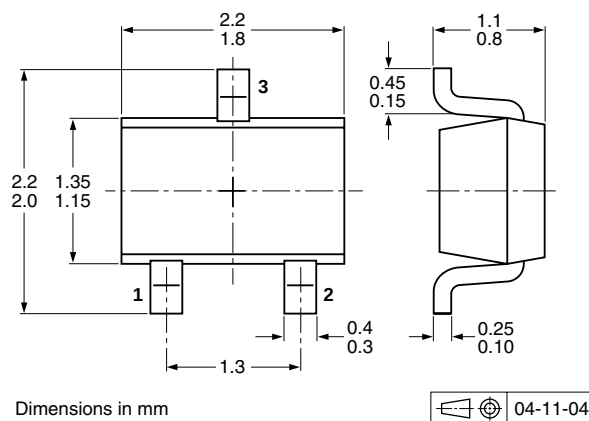


Fig 9. Package outline BAV99W (SOT323/SC-70)

## 10. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.<sup>[1]</sup>

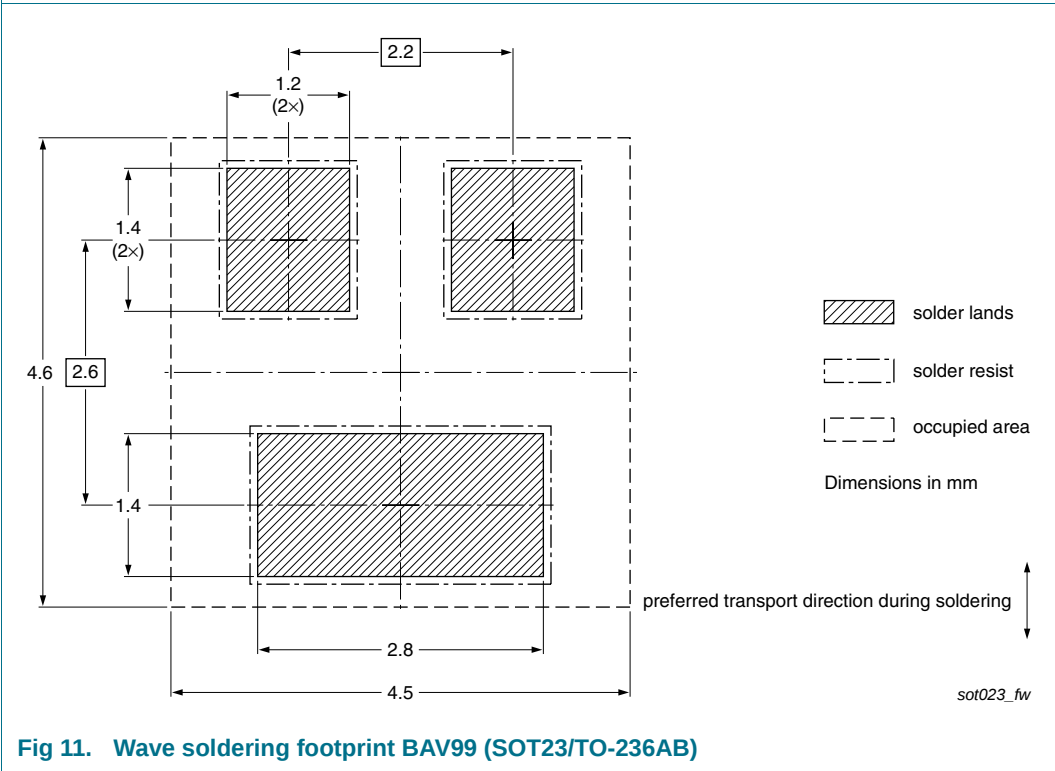
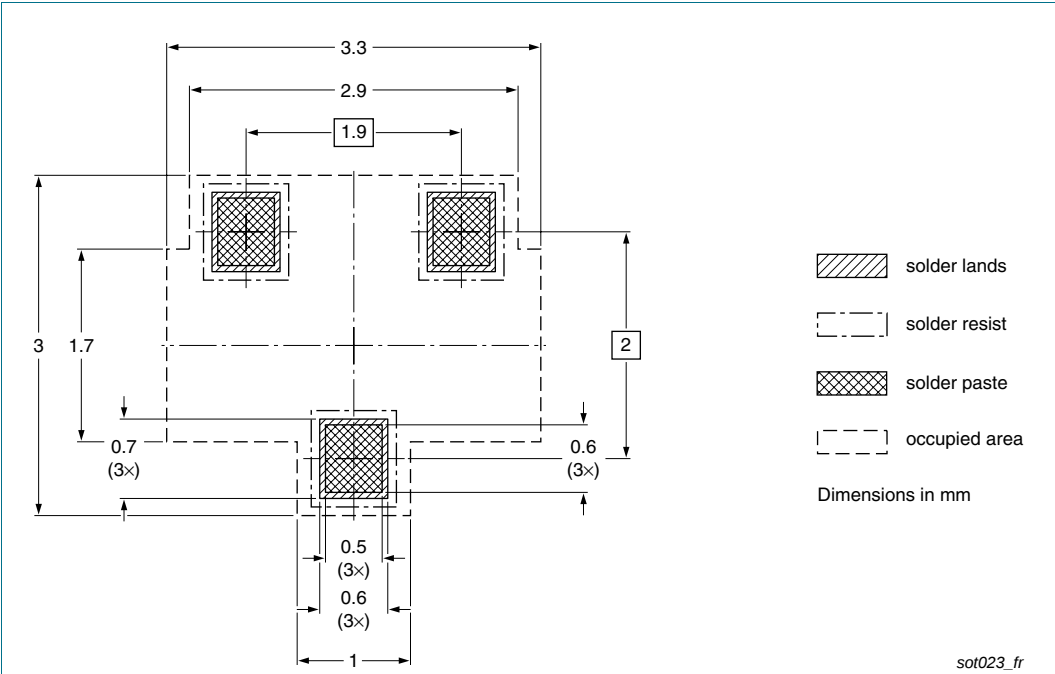
| Type number | Package | Description                        | Packing quantity |       |
|-------------|---------|------------------------------------|------------------|-------|
|             |         |                                    | 3000             | 10000 |
| BAV99       | SOT23   | 4 mm pitch, 8 mm tape and reel     | -215             | -235  |
| BAV99S      | SOT363  | 4 mm pitch, 8 mm tape and reel; T1 | [2] -115         | -135  |
|             |         | 4 mm pitch, 8 mm tape and reel; T2 | [3] -125         | -165  |
| BAV99W      | SOT323  | 4 mm pitch, 8 mm tape and reel     | -115             | -135  |

[1] For further information and the availability of packing methods, see [Section 14](#).

[2] T1: normal taping

[3] T2: reverse taping

11. Soldering



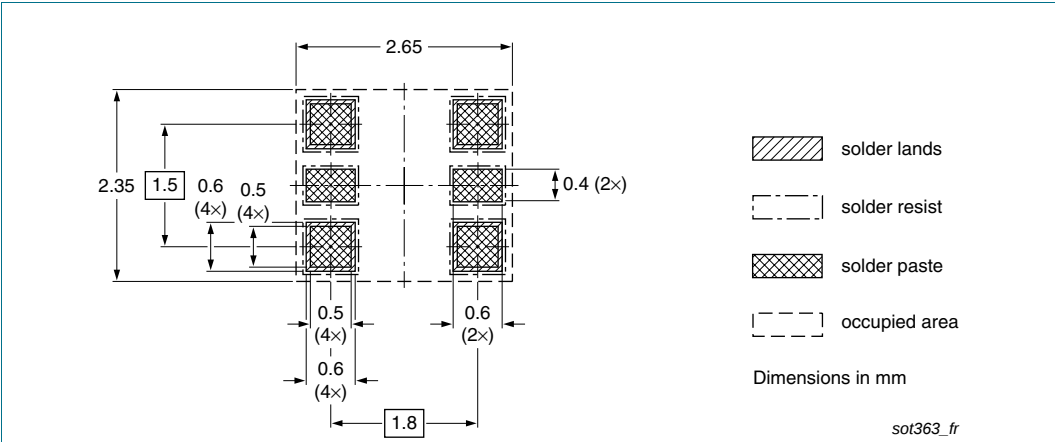


Fig 12. Reflow soldering footprint BAV99S (SOT363/SC-88)

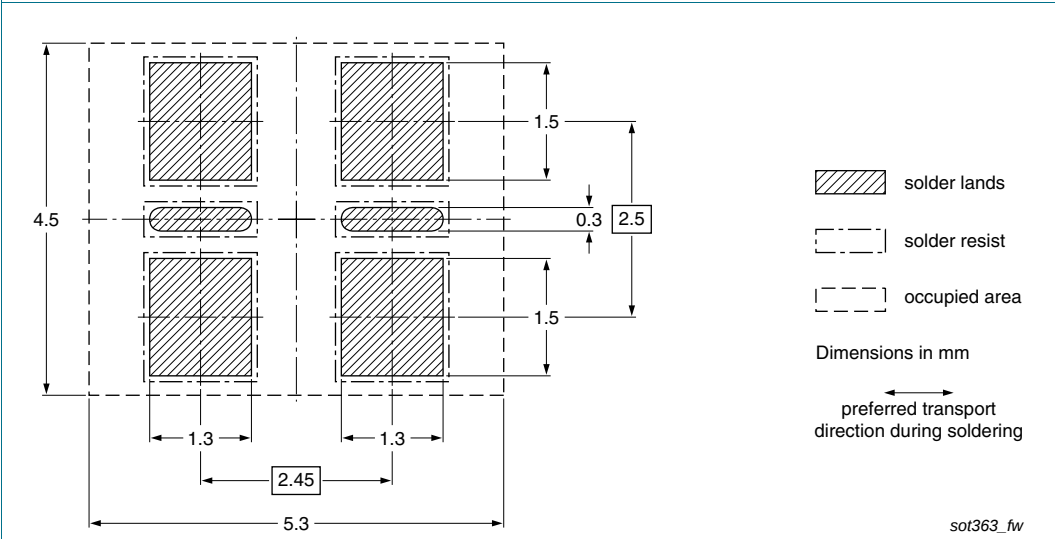


Fig 13. Wave soldering footprint BAV99S (SOT363/SC-88)

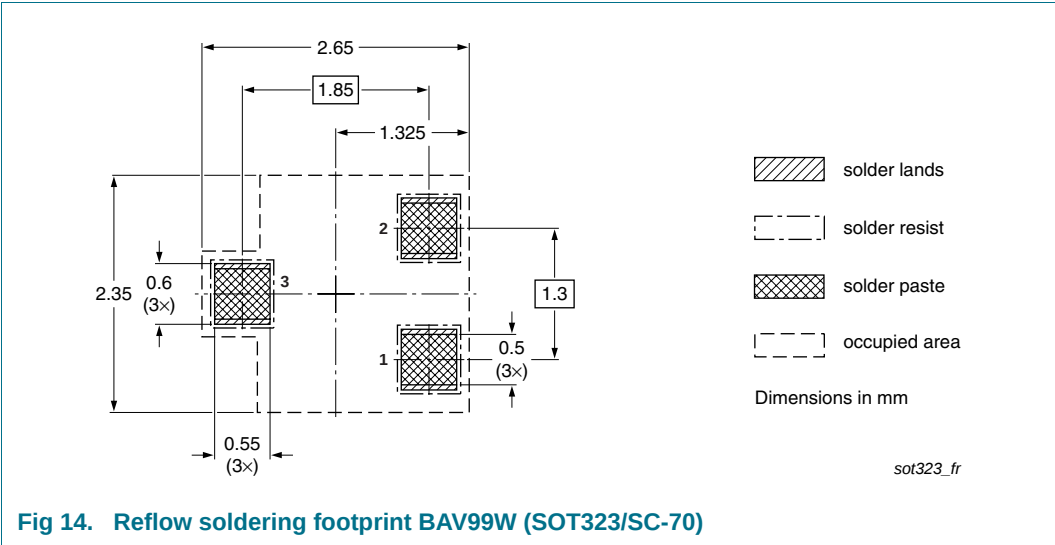


Fig 14. Reflow soldering footprint BAV99W (SOT323/SC-70)

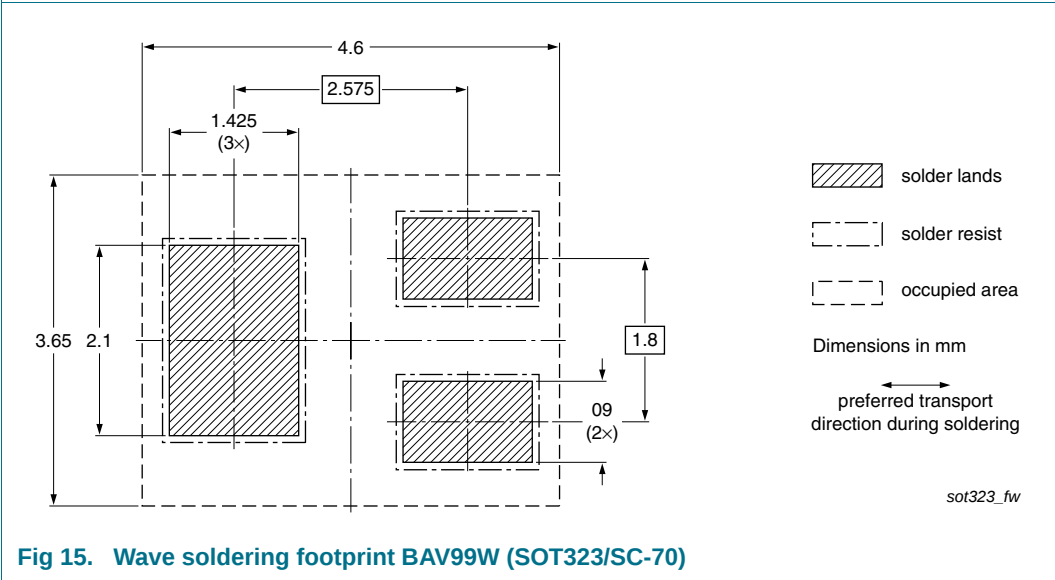


Fig 15. Wave soldering footprint BAV99W (SOT323/SC-70)

## 12. Revision history

Table 10. Revision history

| Document ID    | Release date                                                                                                                                                                                                                                                                                                                | Data sheet status     | Change notice | Supersedes                      |
|----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|---------------|---------------------------------|
| BAV99_SER_8    | 20101118                                                                                                                                                                                                                                                                                                                    | Product data sheet    | -             | BAV99_SER_7                     |
| Modifications: | <ul style="list-style-type: none"><li>• <a href="#">Section 4 "Marking"</a>: marking placeholder explanation in table footer updated</li><li>• <a href="#">Section 5 "Limiting values"</a>: <math>P_{tot}</math> condition for BAV99S corrected</li><li>• <a href="#">Section 13 "Legal information"</a>: updated</li></ul> |                       |               |                                 |
| BAV99_SER_7    | 20100414                                                                                                                                                                                                                                                                                                                    | Product data sheet    | -             | BAV99_SER_6                     |
| BAV99_SER_6    | 20100310                                                                                                                                                                                                                                                                                                                    | Product data sheet    | -             | BAV99_SER_5                     |
| BAV99_SER_5    | 20080820                                                                                                                                                                                                                                                                                                                    | Product data sheet    | -             | BAV99_4<br>BAV99S_3<br>BAV99W_4 |
| BAV99_4        | 20011015                                                                                                                                                                                                                                                                                                                    | Product specification | -             | BAV99_3                         |
| BAV99S_3       | 20010514                                                                                                                                                                                                                                                                                                                    | Product specification | -             | BAV99S_N_2                      |
| BAV99W_4       | 19990511                                                                                                                                                                                                                                                                                                                    | Product specification | -             | BAV99W_3                        |

## 13. Legal information

### 13.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

### 13.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Short data sheet** — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 13.3 Disclaimers

**Limited warranty and liability** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

**Terms and conditions of commercial sale** — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nxp.com/profile/terms>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

## 13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

## 14. Contact information

---

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)

## 15. Contents

---

|           |                                          |           |
|-----------|------------------------------------------|-----------|
| <b>1</b>  | <b>Product profile</b> . . . . .         | <b>1</b>  |
| 1.1       | General description . . . . .            | 1         |
| 1.2       | Features and benefits . . . . .          | 1         |
| 1.3       | Applications . . . . .                   | 1         |
| 1.4       | Quick reference data . . . . .           | 1         |
| <b>2</b>  | <b>Pinning information</b> . . . . .     | <b>2</b>  |
| <b>3</b>  | <b>Ordering information</b> . . . . .    | <b>2</b>  |
| <b>4</b>  | <b>Marking</b> . . . . .                 | <b>2</b>  |
| <b>5</b>  | <b>Limiting values</b> . . . . .         | <b>3</b>  |
| <b>6</b>  | <b>Thermal characteristics</b> . . . . . | <b>4</b>  |
| <b>7</b>  | <b>Characteristics</b> . . . . .         | <b>4</b>  |
| <b>8</b>  | <b>Test information</b> . . . . .        | <b>6</b>  |
| 8.1       | Quality information . . . . .            | 6         |
| <b>9</b>  | <b>Package outline</b> . . . . .         | <b>7</b>  |
| <b>10</b> | <b>Packing information</b> . . . . .     | <b>7</b>  |
| <b>11</b> | <b>Soldering</b> . . . . .               | <b>8</b>  |
| <b>12</b> | <b>Revision history</b> . . . . .        | <b>11</b> |
| <b>13</b> | <b>Legal information</b> . . . . .       | <b>12</b> |
| 13.1      | Data sheet status . . . . .              | 12        |
| 13.2      | Definitions . . . . .                    | 12        |
| 13.3      | Disclaimers . . . . .                    | 12        |
| 13.4      | Trademarks . . . . .                     | 13        |
| <b>14</b> | <b>Contact information</b> . . . . .     | <b>13</b> |
| <b>15</b> | <b>Contents</b> . . . . .                | <b>14</b> |

---

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

---

© NXP B.V. 2010.

All rights reserved.

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)

Date of release: 18 November 2010

Document identifier: BAV99\_SER